

Specification for Approval

DEVICE NUMBER: BL-BJCUBGE2CB-1

CUSTOMER:

SAMPLES ATTACHED AREA

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2015/3/19	1.0	1.0	1.0	1.0					Initial Released
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FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

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ISSUED	APPROVED	PREPARED		
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2015.03.19	2015.03.19	2015.03.19		
孝 嚴	曉峰	家		



BL-BJCUBGE2CB-1

Features:

1. Chip material: AlGaInP/GaAs (Amber)
AlGaINP/GaAs (Red)

and AlGaInP/GaAs (Green)
2. Emitted color : Amber and Red

and Green

3. Lens Appearance: White Diffused

4. Low power consumption.

5. High efficiency.

6. Versatile mounting on P.C. Board or panel.

7. Low current requirement.

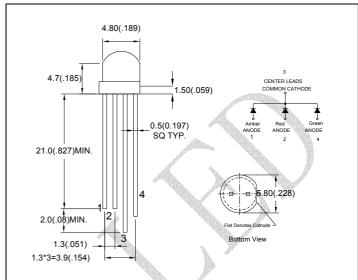
8. 5mm diameter package

This product don't contained restriction substance, compliance RoHS standard.

Applications:

- 1. TV set
- 2. Monitor
- 3. Telephone
- 4. Computer
- 5. Circuit board

Package dimensions:



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Amber	Red	Green	Unit
Power Dissipation	Pd	80	80	80	mW
Forward Current	I _F	30	30	30	mA
Peak Forward Current	I _{FP}	150	150	150	mA
Reverse Voltage	V _R	5			V
Operating Temperature Topr					
Storage Temperature Tstg					

*1Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

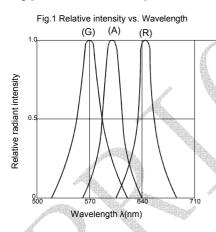


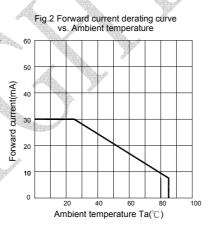
BL-BJCUBGE2CB-1

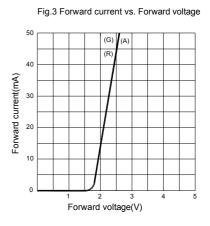
■ Electrical and optical characteristics(Ta=25°C)

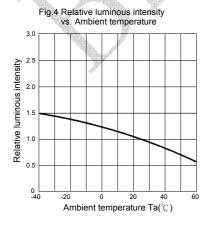
Parameter	Symbol	Condition	Color	Min.	Тур.	Max.	Unit
	.,		Amber		2.0	2.6	
Forward Voltage	V_{F}	I _F =20mA	Red Green	-	2.0 2.0	2.6 2.6	V
			Amber		110	2.0	
Luminous Intensity	lv	I _F =20mA	Red	-	60	<u>-</u>	mcd
			Green		35		
			Amber		de		
Reverse Current	I_R	V _R =5V	Red	-	-	100	μA
			Green		A Spirite State St		
			Amber		610		
Peak Wave Length	λр	I _F =20mA	Red	-	645		nm
			Green		568		F.
			Amber	600	-	612	
Dominant Wave Length	λd	I _F =20mA	Red	624	-	634	nm
			Green	560	-	574	
			Amber		17		
Spectral Line Half-width	Δλ	I _F =20mA	Red	-	20	-	nm
			Green		30		
		a de	Amber				
Viewing Angle	2θ _{1/2}	I _F =20mA	Red	-	160	-	deg
			Green				

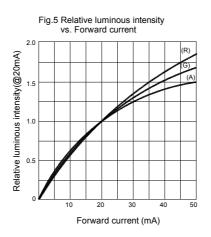
Typical Electro-Optical Characteristics Curves

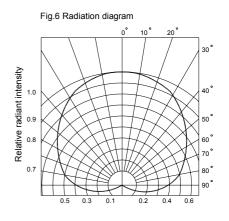














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Reliability Test

Classification	Test Item	Reference Standard	Test Conditions	Result
	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1	I_F =20mA Ta=+25 $^{\circ}$ C±5 $^{\circ}$ C Test time=1,000hrs	0/32
Endurance	High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B-11	Ta=+85°C±5°C RH=90%-95% Test time=240hrs	0/32
Test	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	High Ta=+85°C±5°C Test time=1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-12	Low Ta=-45°C±5°C Test time=1,000hrs	0/32
	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4	Ta: $+85^{\circ}$ C(30min) ~ $+25^{\circ}$ C(5min) ~ -45° C(30min) ~ $+25^{\circ}$ C(5min) Test Time : 70min/ctcle 10cycle	0/32
Environmental	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	-45°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle	0/32
Environmental Test	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1	Preheating: 120°C, within 120-180 sec. Operation heating: 255°C±5°C within 5 sec.260°C (Max)	0/32
		MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 JIS C 7021:A-2	T.sol=230±5°C Dwell Time=5±1secs	0/32

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	I _F =20mA	Over U ¹ x1.2
Reverse current	I _R (uA)	V _R =5V	Over U ¹ x2
Luminous intensity	lv (mcd)	I _F =20mA	Below S ¹ X0.5

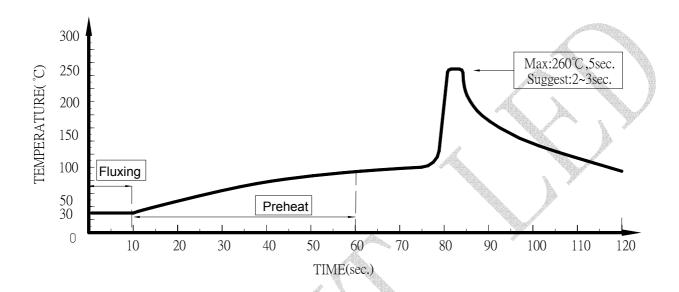
Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

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Dip Soldering



- Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- Although the soldering condition is recommended above,soldering at the lowest possible temperature is feasible for the LEDs

IRON Soldering

300℃ Within 3 sec.,One time only.